Standard Specification for Copper-Silicon Alloy Wire for General Applications¹

This standard is issued under the fixed designation B99/B99M; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

This standard has been approved for use by agencies of the Department of Defense.

1. Scope*

- 1.1 This specification establishes the requirements for round, rectangular, and square wire for general applications other than for electrical transmission cable. The alloys involved are UNS Nos. C65100 and C65500.
- 1.2 *Units*—Values stated in either inch-pound units or SI units are to be regarded separately as standard. Within the text, SI units are shown in brackets. The values stated in each system may not be exact equivalents; therefore, each system shall be used independently of the other. Combining values from the two systems may result in nonconformance with the standard.

2. Referenced Documents

- 2.1 ASTM Standards:²
- B250/B250M Specification for General Requirements for Wrought Copper Alloy Wire
- E8/E8M Test Methods for Tension Testing of Metallic Materials
- E62 Test Methods for Chemical Analysis of Copper and Copper Alloys (Photometric Methods) (Withdrawn 2010)³ E112 Test Methods for Determining Average Grain Size
- E478 Test Methods for Chemical Analysis of Copper Alloys

3. General Requirements

- 3.1 The following sections of Specification B250/B250M constitute a part of this specification.
 - 3.1.1 Terminology,
 - 3.1.2 Materials and Manufacture,
 - 3.1.3 Workmanship, Finish, and Appearance,
 - 3.1.4 Sampling,
- ¹ This specification is under the jurisdiction of ASTM Committee B05 on Copper and Copper Alloys and is the direct responsibility of Subcommittee B05.02 on Rod, Bar, Wire, Shapes and Forgings.
- Current edition approved Oct. 1, 2011. Published November 2011. Originally approved in 1935. Last previous edition approved in 2006 as B99/B99M 06. DOI: 10.1520/B0099_B0099M-11.
- ² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.
- ³ The last approved version of this historical standard is referenced on www.astm.org.

- 3.1.5 Number of Tests and Retests,
- 3.1.6 Specimen Preparation,
- 3.1.7 Test Methods,
- 3.1.8 Significance of Numerical Limits,
- 3.1.9 Inspection,
- 3.1.10 Rejection and Rehearing,
- 3.1.11 Certification,
- 3.1.12 Mill Test Report,
- 3.1.13 Packaging and Package Marking, and
- 3.1.14 Supplementary Requirements.
- 3.2 In addition, when a section with a title identical to that referenced in 3.1, above, appears in this specification, it contains additional requirements which supplement those appearing in Specification B250/B250M.

4. Ordering Information

- 4.1 Include the following information when placing orders for product under this specification, as applicable:
 - 4.1.1 ASTM designation and year of issue,
 - 4.1.2 Copper Alloy UNS No.,
 - 4.1.3 Temper,
- 4.1.4 Dimensions (diameter, distance between parallel surfaces, width, and thickness),
 - 4.1.5 How furnished (coil, reel, and so forth),
 - 4.1.6 Total weight of each size, and
- 4.1.7 If product is purchased for agencies of the U.S. government (see the Supplementary Requirements section of Specification B250/B250M).
- 4.2 The following options are available and should be specified at the time of placing of the order when required:
 - 4.2.1 Heat identification or traceability details,
 - 4.2.2 Certification,
 - 4.2.3 Mill test reports, and
 - 4.2.4 Special packaging and package markings.

5. Chemical Composition

- 5.1 The product shall conform to the chemical composition requirements in Table 1 for the Copper Alloy UNS No. designation specified in the ordering information.
- 5.1.1 These composition limits do not preclude the presence of other elements. By agreement between the manufacturer and

TABLE 1 Chemical Requirements

	Composition, % max Copper Alloy UNS No.		
	C65100	C65500	
Copper (incl silver)	remainder	remainder	
Lead	0.05	0.05	
Iron	0.8	0.8	
Zinc	1.5	1.5	
Manganese	0.7	0.50-1.3	
Silicon	0.8-2.0	2.8-3.8	
Nickel (incl cobalt)		0.6	

the purchaser, limits may be established and analysis required for unnamed elements.

- 5.2 For alloys in which copper is listed as "remainder," copper is the difference between the sum of results for all elements determined and 100 %.
- 5.3 When all elements in Table 1 are determined, the sum of results shall be 99.5 % min.

6. Temper

- 6.1 The standard tempers for products described in this specification are given in Table 2.
- 6.1.1 Product made to H04 (full hard) temper is generally not available in sizes larger than 0.500 in. [12 mm] in diameter or distance between parallel faces.
- 6.1.2 Product made to H08 (spring) temper is generally not available in sizes larger than 0.250 in. [6 mm] in diameter or distance between parallel faces.

7. Grain Size for Annealed Temper

- 7.1 Grain size shall be the standard requirement for all product in annealed temper.
- 7.2 The average grain size of O61 (annealed) temper wire shall not exceed 0.040 mm, but the wire must be completely recrystallized.

7.3 Acceptance or rejection based upon grain size shall depend only on the average grain size of test specimens taken from each of two sample portions and each specimen shall be within the limits prescribed in 7.2 when determined in accordance with Test Methods E112.

8. Mechanical Property Requirements

- 8.1 Tensile Strength Requirements:
- 8.1.1 Product furnished under this specification shall conform to the tensile requirements prescribed in Table 2, when tested in accordance with Test Methods E8/E8M.

9. Performance Requirements

- 9.1 Bending Requirements:
- 9.1.1 Wire in sizes up to 0.250 in. [6 mm] inclusive produced to this specification shall be capable of being bent or wrapped one full turn (360°) around its own diameter, or distance between parallel faces, without developing cracks or other flaws visible to the unaided eye on the outside surface of the bend.

Note 1—Test specimens that include brazed or welded areas shall not be used for bend test purposes.

10. Dimensions, Mass, and Permissible Variations

10.1 The dimensions and tolerances for product described by this specification shall be as specified in Specification B250/B250M with particular reference to the following tables and related paragraphs in that specification:

10.1.1 Diameter or Distance Between Parallel Surfaces:

10.1.1.1 Copper Alloy UNS No. C65100—Table 1.

10.1.1.2 Copper Alloy UNS No. C65500—Table 2.

10.1.2 Thickness:

10.1.2.1 Copper Alloy UNS No. C65100—Table 3.

10.1.2.2 Copper Alloy UNS No. C65500—Table 4.

10.1.3 Width:

10.1.3.1 Copper Alloy UNS No. C65100—Table 5.

10.1.3.2 Copper Alloy UNS No. C65500—Table 6.

TABLE 2 Mechanical Requirements

Temper		Tensile Strength		Elongation in 2 in. [50 mm] min %, for Wire Over
Code	Name	ksi	MPa	0.500 in. [12 mm] in Diameter
		Copper Alloy UNS No. C65100		
O61	annealed	38–55	260–380	40
H00	eighth-hard	50-65	345-450	20
H01	quarter-hard	60–75	415–515	15
H02	half-hard	75–95	515-655	10
H04	hard ^A	90–110	620-760	8
H08	spring ^B	100 min	690 min	6
		Copper Alloy UNS No. C65500		
O61	annealed	55–70	380–485	47
H00	eighth-hard	62–78	425-540	28
H01	quarter-hard	72-90	495-620	18
H02	half-hard	90–110	620-760	10
H04	hard ^A	115–135	790–930	6
H08	spring ^B	130 min	900 min	4

^A Hard (H04) temper is not generally available in sizes over 0.500 in. [12 mm].

^B Spring (H08) temper is not generally available in sizes over 0.250 in. [6 mm].



11. Test Methods

11.1 Chemical Analysis:

11.1.1 In cases of disagreement, determine the composition using the following methods:

 Element
 Methods

 Copper
 E478

 Silicon
 E62

 Lead
 E478 (AA)

 Iron
 E478

 Zinc
 E478 (titrametric)

 Nickel
 E478 (photometric)

 Manganese
 E62

11.1.2 Test method(s) to be followed for the determination of elements resulting from contractual or purchase order agreement shall be as agreed upon between the manufacturer or supplier and the purchaser.

12. Keywords

12.1 copper-silicon alloy wire; general purpose wire; non-electrical wire; UNS C65100 wire; UNS C65500 wire

SUMMARY OF CHANGES

Committee B05 has identified the principal changes to this specification that have been incorporated since the 2006 issue as follows:

(1) Editorial changes were made in accordance with B950.

ASTM International takes no position respecting the validity of any patent rights asserted in connection with any item mentioned in this standard. Users of this standard are expressly advised that determination of the validity of any such patent rights, and the risk of infringement of such rights, are entirely their own responsibility.

This standard is subject to revision at any time by the responsible technical committee and must be reviewed every five years and if not revised, either reapproved or withdrawn. Your comments are invited either for revision of this standard or for additional standards and should be addressed to ASTM International Headquarters. Your comments will receive careful consideration at a meeting of the responsible technical committee, which you may attend. If you feel that your comments have not received a fair hearing you should make your views known to the ASTM Committee on Standards, at the address shown below.

This standard is copyrighted by ASTM International, 100 Barr Harbor Drive, PO Box C700, West Conshohocken, PA 19428-2959, United States. Individual reprints (single or multiple copies) of this standard may be obtained by contacting ASTM at the above address or at 610-832-9585 (phone), 610-832-9555 (fax), or service@astm.org (e-mail); or through the ASTM website (www.astm.org). Permission rights to photocopy the standard may also be secured from the ASTM website (www.astm.org/COPYRIGHT/).